# **MN3207**

## 1024-STAGE LOW VOLTAGE OPERATION LOW NOISE BBD

#### General description

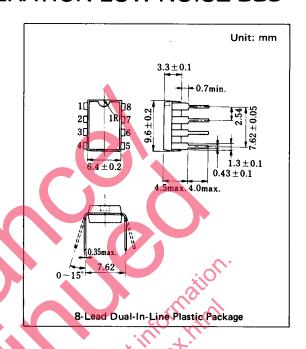
The MN3207 is a 1024-stage long delay low noise BBD that provides a signal delay of up to 51.2ms and is particularly suitable as a device for generation of reverberation effect in audio equipment such as low voltage operation portable stereo and radio cassette recorders.

#### ■ Features

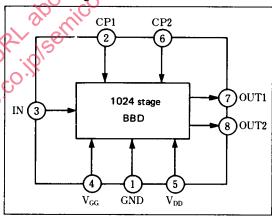
- Variable delay of audio signals: 2.56ms ~ 51.2ms.
- Wide supply votage: 4 ~ 10V.
- No insertion loss: Li = 0dB typ.
- Wide dynamic range: S/N = 73dB typ.
- Low distortion: THD = 0.4% typ. (V; = 0.25 Vrms).
- Clock frequency range: 10KHz ~ 200KHz.
- N-channel silicon gate process.
- 8-lead dual-in-line plastic package.

### Applications

- Reverberation and echo effects of audio equipment such as radio cassette recorder, car radio, portable radio, portable stereo, echo microphone and pre-taped musical accompaniment (Karaoke), etc.
- Sound effect in electronic musical instruments.
- Variable or fixed delay of analog signals.



### ■ Block Diagram





### Quick Reference Data

Item	Symbol	Value	Unit		
Supply Voltage	V <sub>DD</sub> , V <sub>GG</sub>	+ 5, 14 V <sub>DD</sub>	V		
Signal Delay Time	t <sub>D</sub>	2.56~51.2	ms		
Total Harmonic Distortion	THD	0.4	%		
Signal to Noise Ratio	S/N	73	dB		

### ■ Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Rating	Unit	
Terminal Voltage	V <sub>DD</sub> , V <sub>GG</sub> , V <sub>CP</sub> , V <sub>I</sub>	-0.3~+11	V	
Output Voltage	Vo	-0.3~+11	V	
Operating Temprature	Topr	-20~+60	c	
Storage Temperature	Tstg	<b>−55~+</b> 125	C	

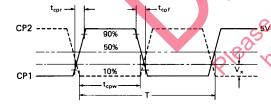
### ■ Operating Condition (Ta = 25°C)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Drain Supply Voltage	V <sub>DD</sub>		+4	+5	+10	V
Gate Supply Voltage	V <sub>GG</sub>			14 V <sub>DD</sub>		٧
Clock Voltage "H" Level	V <sub>CPH</sub>			V <sub>DD</sub>		٧
Clock Voltage "L" Level	V <sub>CPL</sub>		0		+1	٧
Clock frequency	for		10		200	kHz
Clock Pulse Width *1	t <sub>CPW</sub>				0.5T *2	
Clock Rise Time *1	t <sub>CPr</sub>				500	ns
Clock Fall Time *1	topf				500	ns
Clock Input Capacitance	C <sub>CP</sub>				700	pF
Clock Cross Point *1	V <sub>X</sub>		0	~	0.3V <sub>CPH</sub>	٧

## ■ Electrical Characteristics (Ta = 25°C, $V_{DD} = V_{CPH} = 5V$ , $V_{CPL} = 0V$ , $V_{GG} = 4.67V$ , $R_L = 100kΩ$ )

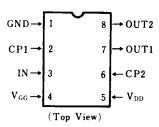
Item	Symbol	Condition	Win.	Typ.	Max.	Unit
Signal Delay Time	t <sub>D</sub>		2.56		51.2	ms
Input Signal Frequency	fi	$f_{cp} = 40$ kHz, $V_i = 0.35$ Vrms 3dB down (0dB at $f_i = 1$ kHz) = 1kHz)	GO,			kHz
Input Signal Swing	Vi	f <sub>CP</sub> =40kHz, f <sub>i</sub> =1kHz, THD=2.5%	0.36			Vrms
Insertion Loss	Li	fcp=40kHz, fi=1kHz, Vi=0.36Vrms	-4	0	4	dB
Total Harmonic Distortion	THD	f <sub>CP</sub> =40kHz, f <sub>i</sub> =1kHz, V <sub>i</sub> =0.25Vrms		0.4	2.5	%
Noise Voltage	V <sub>no</sub>	f <sub>cp</sub> = 100kHz, Weighted by "A" curve			0.25	mVrms
Signal to Noise Ratio	S/N	Cp 100kHz, Weighted by A curve		73		dB

#### \*1 Clock Pulse Waveforms

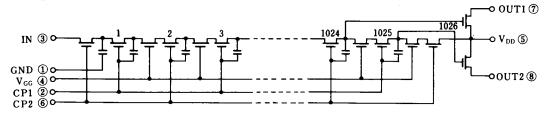


\*2 T = 1/f<sub>CP</sub> (Clock Period)

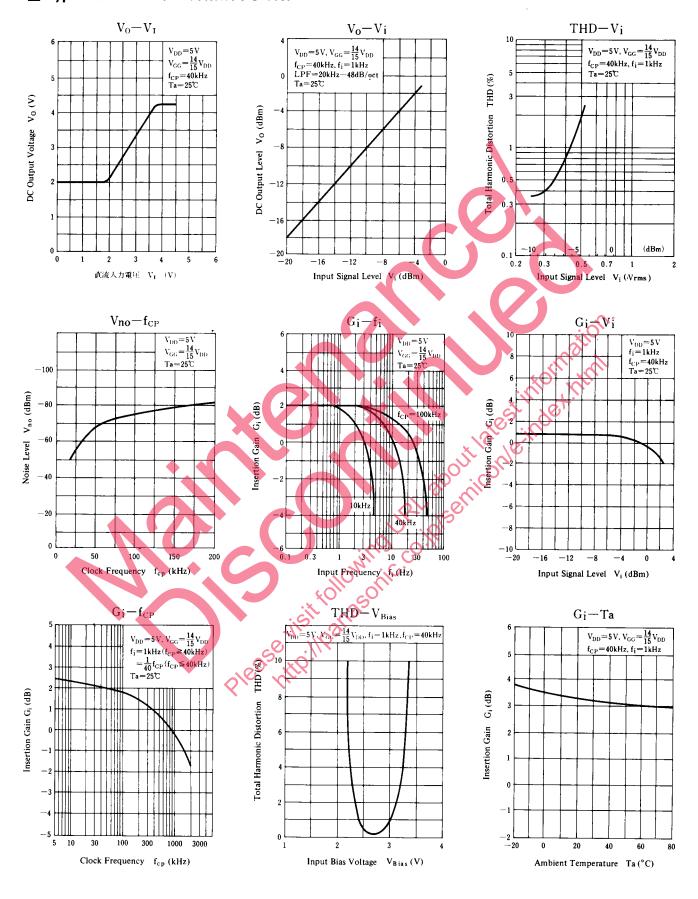
### ■ Terminal Assignments



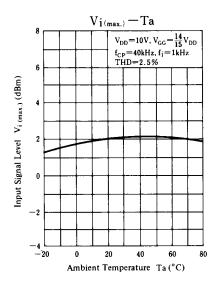
### **■** Circuit Diagram

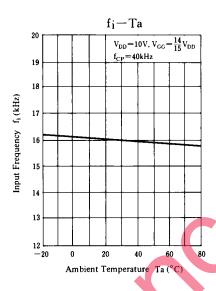


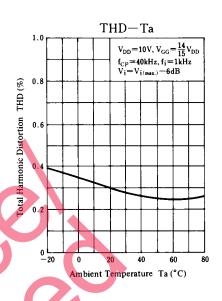
### **■** Typical Electrical Characteristic Curves



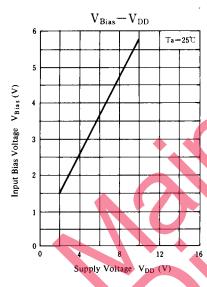
Panasonic -82-

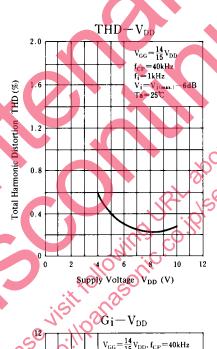


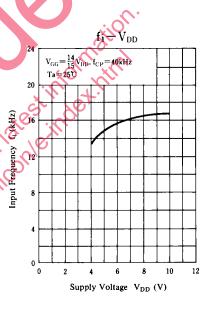


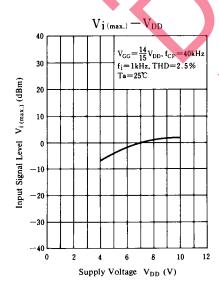


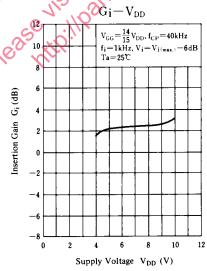
### ■ Supply Voltage Characteristics

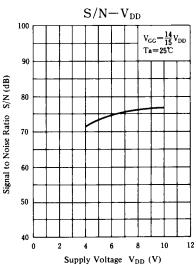




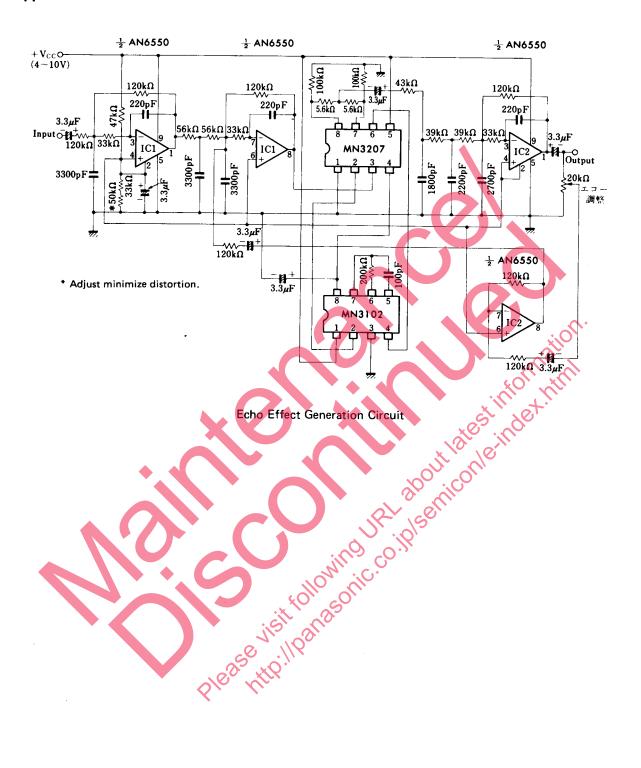








### ■ Application Circuit



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